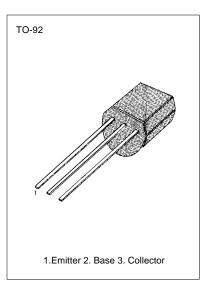
## HIGH VOLTAGE TRANSISTOR

Collector-Emitter Voltage: V<sub>CEO</sub>= 250V
Collector Dissipation: P<sub>C</sub> (max)=625mW

# ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C)

Characteristic	Symbol	Rating	Unit
Collector-Base Voltage Collector-Emitter Voltage Emitter-Base Voltage Collector Current Collector Dissipation Junction Temperature Storage Temperature	V <sub>CEO</sub> V <sub>CEO</sub> V <sub>EBO</sub> I <sub>C</sub> P <sub>C</sub> T <sub>J</sub> T <sub>STG</sub>	250 250 6 500 625 150 -55 ~ 150	V V mA mW °C ℃



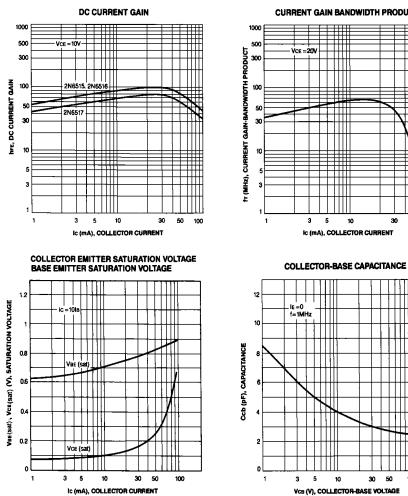
# ELECTRICAL CHARACTERISTICS (T<sub>A</sub>=25°C)

Characteristic	Symbol	Test Conditions	Min	Тур	Max	Unit
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	$I_{C}=1$ mA, $I_{B}=0$	250			V
* Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	$I_{c}=100\mu A, I_{E}=0$	250			V V
Emitter-Base Breakdown Voltage Collector Cut-off Current	BV <sub>EBO</sub> I <sub>CBO</sub>	I <sub>E</sub> =10μA, I <sub>C</sub> =0 V <sub>CB</sub> =150V, I <sub>E</sub> =0	6		50	nA
Emitter Cut-off Current	ICBO ІЕВО	$V_{BE} = 5V, I_{C} = 0$			50 50	nA
* DC Current Gain	h <sub>EE</sub>	$I_{C}=1mA, V_{CF}=10V$	35		50	
	"FE	I <sub>C</sub> =10mA, V <sub>CE</sub> =10V	50			
		I <sub>C</sub> =30mA, V <sub>CE</sub> =10V	50		300	
		$I_{c}=50mA, V_{cE}=10V$	45		220	
Collector-Emitter Saturation Voltage		I <sub>C</sub> =100mA, V <sub>CE</sub> =10V I <sub>C</sub> =10mA, I <sub>B</sub> =1mA	25			
Collector-Emilier Saturation Voltage	V <sub>CE</sub> (sat)	$I_{c}=20mA$ , $I_{B}=2mA$			0.3	V
		$I_c=30$ mA, $I_B=3$ mA			0.35 0.5	V
		$I_{C}=50mA$ , $I_{B}=5mA$			0.5	V V
Base-Emitter Saturation Voltage	V <sub>BE</sub> (sat)	I <sub>C</sub> =10mA, I <sub>B</sub> =1mA			0.75	v
		$I_{c}=20mA$ , $I_{B}=2mA$			0.85	v
Collector-Base Capacitance		$I_{\rm C}$ =30mA, $I_{\rm B}$ =3mA			0.9	V
Conector-Dase Capacitance	C <sub>OB</sub>	V <sub>CB</sub> =20V, I <sub>E</sub> =0 f=1MHz			6	pF
Current Gain Bandwidth Product	f⊤	$I_c=10mA$ , $V_{cr}=20V$	40		200	NAL I-
	IT		40		200	MHz
Base Emitter On Voltage	V <sub>BE</sub> (on)	$I_C$ =100mA, $V_{CE}$ =10V			2	V

\* Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%









30 50



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